SN54HC646 ... JT OR W PACKAGE

SCLS150B – DECEMBER 1982 – REVISED MAY 1997

- Independent Registers for A and B Buses
- Multiplexed Real-Time and Stored Data
- True Data Paths
- High-Current 3-State Outputs Can Drive up to 15 LSTTL Loads
- Package Options Include Plastic Small-Outline (DW) and Ceramic Flat (W) Packages, Ceramic Chip Carriers (FK), and Standard Plastic (NT) and Ceramic (JT) 300-mil DIPs

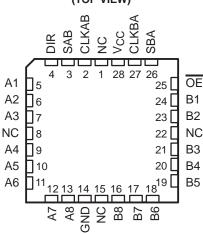
description

The 'HC646 consist of bus-transceiver circuits with 3-state outputs, D-type flip-flops, and control circuitry arranged for multiplexed transmission of data directly from the input bus or from the internal registers. Data on the A or B bus is clocked into the registers on the low-to-high transition of the appropriate clock (CLKAB or CLKBA) input. Figure 1 illustrates the four fundamental busmanagement functions that can be performed with the 'HC646.

Output-enable (\overline{OE}) and direction-control (DIR) inputs control the transceiver functions. In the transceiver mode, data present at the high-impedance port may be stored in either or both registers.

The select-control (SAB and SBA) inputs can multiplex stored and real-time (transparent mode) data. DIR determines which bus receives data when \overline{OE} is active (low). In the isolation mode (\overline{OE} high), A data may be stored in one register and/or B data may be stored in the other register.

SN74HC646.	DW C	DR N	T PACKAGE
(TOP VII	EW)	
d	$\overline{\mathbf{U}}$	-	1
CLKAB [1	24	V _{CC}
SAB [2	23	CLKBA
DIR [3	22	SBA
A1 [4	21	OE
A2 [5	20	B1
A3 [6	19	B2
A4 [7	18	B3
A5 [8	17	B4
A6 [9	16	B5
A7 [10	15	B6
A8 [11	14	B7
GND [12	13	B8
SN54HC6 (46 F TOP VII		CKAGE





When an output function is disabled, the input function is still enabled and can be used to store and transmit data. Only one of the two buses, A or B, may be driven at a time.

The SN54HC646 is characterized for operation over the full military temperature range of -55° C to 125° C. The SN74HC646 is characterized for operation from -40° C to 85° C.



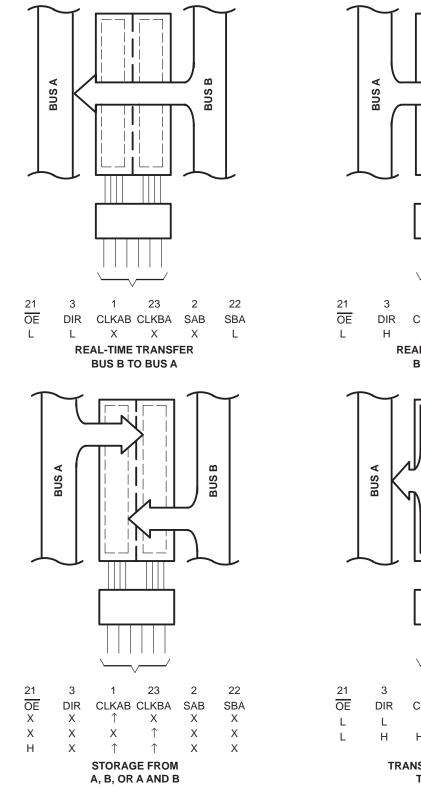
Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

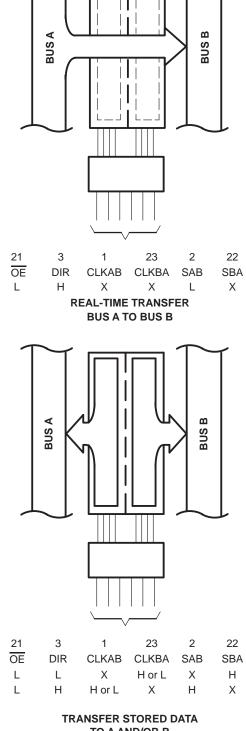
UNLESS OTHERWISE NOTED this document contains PRODUCTION DATA information current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.



Copyright © 1997, Texas Instruments Incorporated

SCLS150B - DECEMBER 1982 - REVISED MAY 1997





TO A AND/OR B

Pin numbers shown are for the DW, JT, NT, and W packages.



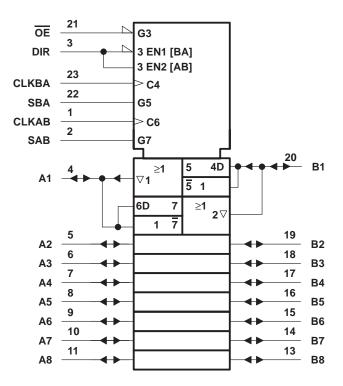


SCLS150B - DECEMBER 1982 - REVISED MAY 1997

	FUNCTION TABLE										
	INPUTS						A I/O				
OE	DIR	CLKAB	CLKBA	SAB	SBA	A1-A8	B1–B8	OPERATION OR FUNCTION			
Х	Х	\uparrow	Х	Х	Х	Input	Unspecified [†]	Store A, B unspecified [†]			
Х	Х	Х	\uparrow	Х	Х	Unspecified [†]	Input	Store B, A unspecified [†]			
Н	Х	\uparrow	\uparrow	Х	Х	Input	Input	Store A and B data			
Н	Х	H or L	H or L	Х	Х	Input disabled	Input disabled	Isolation, hold storage			
L	L	Х	Х	Х	L	Output	Input	Real-time B data to A bus			
L	L	Х	H or L	Х	Н	Output	Input	Stored B data to A bus			
L	Н	Х	Х	L	Х	Input	Output	Real-time A data to B bus			
L	Н	H or L	Х	Н	Х	Input	Output	Stored A data to B bus			

[†] The data-output functions can be enabled or disabled by various signals at OE and DIR. Data-input functions are always enabled; i.e., data at the bus terminals is stored on every low-to-high transition of the clock inputs.

logic symbol[‡]

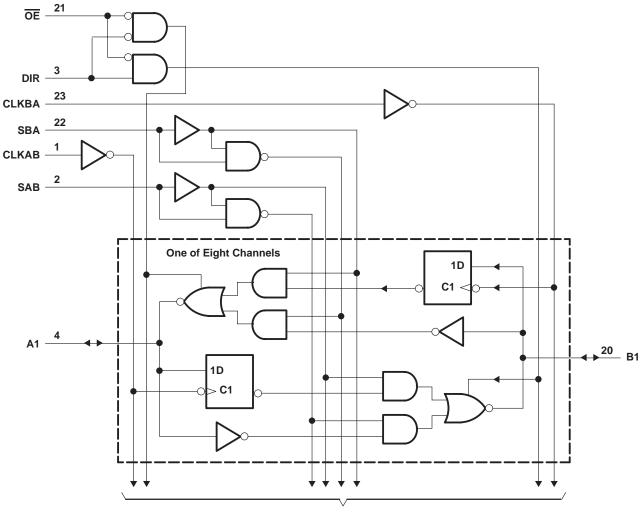


[‡] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12. Pin numbers shown are for the DW, JT, NT, and W packages.



SCLS150B - DECEMBER 1982 - REVISED MAY 1997

logic diagram (positive logic)



To Seven Other Channels

Pin numbers shown are for the DW, JT, NT, and W packages.

absolute maximum ratings over operating free-air temperature range[†]

Supply voltage range, V _{CC}	–0.5 V to 7 V
Input clamp current, I_{IK} ($V_I < 0$ or $V_I > V_{CC}$) (see Note 1)	
Output clamp current, I _{OK} (V _O < 0 or V _O > V _{CC}) (see Note 1)	±20 mA
Continuous output current, $I_O (V_O = 0 \text{ to } V_{CC})$	±35 mA
Continuous current through V _{CC} or GND	±70 mA
Package thermal impedance, θ_{JA} (see Note 2): DW package	81°C/W
NT package	67°C/W
Storage temperature range, T _{stg}	. −65°C to 150°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

2. The package thermal impedance is calculated in accordance with JESD 51, except for through-hole packages, which use a trace length of zero.



SCLS150B - DECEMBER 1982 - REVISED MAY 1997

recommended operating conditions

			SN	SN54HC646			N74HC64	6	UNIT
			MIN	IIN NOM MAX MIN NOM MAX		UNIT			
Vcc	Supply voltage		2	5	6	2	5	6	V
		V _{CC} = 2 V	1.5			1.5			
VIH	High-level input voltage	V _{CC} = 4.5 V	3.15			3.15			V
		VCC = 6 V	4.2		W	4.2			
	Low-level input voltage	V _{CC} = 2 V	0	1	0.5	0		0.5	V
VIL		V _{CC} = 4.5 V	0	A.	1.35	0		1.35	
		V _{CC} = 6 V	0	5	1.8	0		1.8	
VI	Input voltage		0	50	VCC	0		VCC	V
Vo	Output voltage		0)	VCC	0		VCC	V
		V _{CC} = 2 V	0		1000	0		1000	
tt	Input transition (rise and fall) time	V _{CC} = 4.5 V	0		500	0		500	ns
		V _{CC} = 6 V	0		400	0		400	
Тд	Operating free-air temperature		-55		125	-40		85	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

	AMETER	TEST CO	NDITIONS	Vee	Т	A = 25°C	;	SN54H	IC646	SN74H	C646	UNIT	
PAR	AWEIER	TEST CC	ONDITIONS	Vcc	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNIT	
				2 V	1.9	1.998		1.9		1.9			
			I _{OH} = -20 μA	4.5 V	4.4	4.499		4.4		4.4			
∨он		$V_I = V_{IH} \text{ or } V_{IL}$		6 V	5.9	5.999		5.9		5.9		V	
			I _{OH} = -6 mA	4.5 V	3.98	4.3		3.7	2	3.84			
			I _{OH} = -7.8 mA	6 V	5.48	5.8		5.2	15	5.34			
				2 V		0.002	0.1		¥0.1		0.1		
			I _{OL} = 20 μA	4.5 V		0.001	0.1	4	2 0.1		0.1		
VOL		$V_I = V_{IH} \text{ or } V_{IL}$		6 V		0.001	0.1	50	0.1		0.1	V	
			IOL = 6 mA	4.5 V		0.17	0.26	20	0.4		0.33		
			I _{OL} = 7.8 mA	6 V		0.15	0.26	44	0.4		0.33		
Ц	Control inputs	$V_{I} = V_{CC} \text{ or } 0$		6 V		±0.1	±100		±1000		±1000	nA	
IOZ	A or B	$V_{O} = V_{CC} \text{ or } 0$		6 V		±0.01	±0.5		±10		±5	μΑ	
ICC		$V_I = V_{CC} \text{ or } 0,$	IO = 0	6 V			8		160		80	μΑ	
Ci	Control inputs			2 V to 6 V		3	10		10		10	pF	



SN54HC646, SN74HC646 OCTAL BUS TRANSCEIVERS AND REGISTERS WITH 3-STATE OUTPUTS SCLS150B – DECEMBER 1982 – REVISED MAY 1997

timing requirements over recommended operating free-air temperature range (unless otherwise noted)

		V	T _A =	25°C	SN54F	IC646	SN74H	IC646	UNIT
		Vcc	MIN	MAX	MIN	MAX	MIN	MAX	UNIT
		2 V	0	6	0	4.3	0	5.5	
fclock	Clock frequency	4.5 V	0	31	0	22	0	27	MHz
	6 V	0	36	0	25	0	31		
		2 V	80		115	ĬE,	95		
tw	Pulse duration, CLKBA or CLKAB high or low	4.5 V	16		23	IEI,	19		ns
		6 V	14		20	Q	16		
		2 V	100		150	•	125		
t _{su}	Setup time, A before CLKAB \uparrow or B before CLKBA \uparrow	4.5 V	20		30		25		ns
		6 V	17		26		21		
		2 V	5		5		5		
t _h	Hold time, A after CLKAB \uparrow or B after CLKBA \uparrow	4.5 V	5		5		5		ns
		6 V	5		5		5		



SCLS150B - DECEMBER 1982 - REVISED MAY 1997

switching characteristics over recommended operating free-air temperature range, $C_L = 50 \text{ pF}$ (unless otherwise noted) (see Figure 2)

PARAMETER	FROM	то	Vec	T,	4 = 25°C	;	SN54H	IC646	SN74H	C646	UNIT	
PARAMETER	(INPUT)	(OUTPUT)	Vcc	MIN	TYP	MAX	MIN	MAX	MIN	MIN MAX		
			2 V	6	11		4.4		5.5			
fmax			4.5 V	31	54		22		27		MHz	
			6 V	36	64		25		31			
			2 V		65	180		270		225		
	CLKBA or CLKAB	A or B	4.5 V		18	36		54		45		
			6 V		14	31		46		38		
			2 V		50	135		205		170		
^t pd	A or B	B or A	4.5 V		14	27		41		34	ns	
			6 V		11	23		35		29		
			2 V		70	190		285		240		
	SBA or SAB [†]	A or B	4.5 V		20	38		57		48		
			6 V		16	32		48		41		
			2 V		85	245	~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~	370		305		
ten	ŌE	A or B	4.5 V		25	49	202	74		61	ns	
			6 V		20	42	702	63		52		
			2 V		85	245	4	370		305		
^t dis	OE	A or B	4.5 V		25	49		74		61	ns	
			6 V		20	42		63		52		
			2 V		80	245		370		305		
ten	DIR	A or B	4.5 V		25	49		74		61	ns	
			6 V		20	42		63		52		
			2 V		80	245		370		305		
^t dis	DIR	A or B	4.5 V		25	49		74		61	ns	
			6 V		20	42		63		52		
			2 V		28	60		90		75		
tt		Any	4.5 V		8	12		18		15	ns	
			6 V		6	10		15		13		

[†] These parameters are measured with the internal output state of the storage register opposite that of the bus input.



SCLS150B - DECEMBER 1982 - REVISED MAY 1997

switching characteristics over recommended operating free-air temperature range, $C_L = 150 \text{ pF}$ (unless otherwise noted) (see Figure 2)

PARAMETER	FROM	то	Vaa	Тд	∖ = 25°C	;	SN54F	IC646	SN74H	SN74HC646	
PARAMETER	(INPUT)	(OUTPUT)	Vcc	MIN	TYP	MAX	MIN	MAX	MIN	MAX 330 66 57 280 56 49 345 69 60 410 82 71 410 82 71 410 82 71 265 53	UNIT
			2 V		90	265		400		330	
	CLKBA or CLKAB	A or B	4.5 V		24	53		80		66	
			6 V		20	46		68		57	
			2 V		70	220		335		280	
^t pd	A or B	B or A	4.5 V		20	44		67		56	ns
			6 V		15	38		57		49	
	SBA or SAB [†]		2 V		80	275		415		345	
		A or B	4.5 V		24	55	4	83		69	
			6 V		20	47	ζς,	70		60	
			2 V		113	330	η_{Q_i}	500		410	
	ŌE	A or B	4.5 V		33	66	JAC	100		82	
+			6 V		27	57	1	85		71	ns
ten			2 V		113	330		500		410	115
	DIR	A or B	4.5 V		33	66		100		82	
			6 V		27	57		85		71	
			2 V		45	210		315		265	
tt		Any	4.5 V		17	42		63		53	ns
			6 V		13	36		53		43	

[†] These parameters are measured with the internal output state of the storage register opposite that of the bus input.

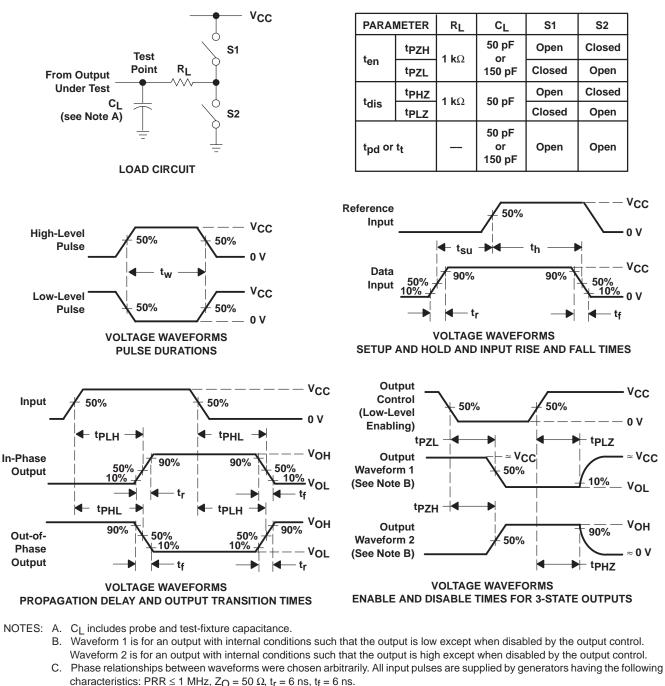
operating characteristics, $T_A = 25^{\circ}C$

	PARAMETER	TEST CONDITIONS	TYP	UNIT
C _{pd}	Power dissipation capacitance	No load	50	pF



SCLS150B - DECEMBER 1982 - REVISED MAY 1997

PARAMETER MEASUREMENT INFORMATION



- D. For clock inputs, fmax is measured when the input duty cycle is 50%.
- E. The outputs are measured one at a time with one input transition per measurement.
- F. tpLz and tpHz are the same as tdis.
- G. t_{PZL} and t_{PZH} are the same as t_{en} .
- H. tPLH and tPHL are the same as tpd.

Figure 2. Load Circuit and Voltage Waveforms



IMPORTANT NOTICE

Texas Instruments and its subsidiaries (TI) reserve the right to make changes to their products or to discontinue any product or service without notice, and advise customers to obtain the latest version of relevant information to verify, before placing orders, that information being relied on is current and complete. All products are sold subject to the terms and conditions of sale supplied at the time of order acknowledgement, including those pertaining to warranty, patent infringement, and limitation of liability.

TI warrants performance of its semiconductor products to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are utilized to the extent TI deems necessary to support this warranty. Specific testing of all parameters of each device is not necessarily performed, except those mandated by government requirements.

CERTAIN APPLICATIONS USING SEMICONDUCTOR PRODUCTS MAY INVOLVE POTENTIAL RISKS OF DEATH, PERSONAL INJURY, OR SEVERE PROPERTY OR ENVIRONMENTAL DAMAGE ("CRITICAL APPLICATIONS"). TI SEMICONDUCTOR PRODUCTS ARE NOT DESIGNED, AUTHORIZED, OR WARRANTED TO BE SUITABLE FOR USE IN LIFE-SUPPORT DEVICES OR SYSTEMS OR OTHER CRITICAL APPLICATIONS. INCLUSION OF TI PRODUCTS IN SUCH APPLICATIONS IS UNDERSTOOD TO BE FULLY AT THE CUSTOMER'S RISK.

In order to minimize risks associated with the customer's applications, adequate design and operating safeguards must be provided by the customer to minimize inherent or procedural hazards.

TI assumes no liability for applications assistance or customer product design. TI does not warrant or represent that any license, either express or implied, is granted under any patent right, copyright, mask work right, or other intellectual property right of TI covering or relating to any combination, machine, or process in which such semiconductor products or services might be or are used. TI's publication of information regarding any third party's products or services does not constitute TI's approval, warranty or endorsement thereof.

Copyright © 1998, Texas Instruments Incorporated